

### IN THE SPECIFICATION

Please amend the Abstract on page 30 as follows:

#### ABSTRACT

[[The]] A method for producing a panel assembly is provided. The panel assembly includes ~~comprises~~ a panel [[(2)]] and a gasket [[(1)]] adhered to the panel and extending along at least a portion of the periphery. ~~For producing the panel assembly a~~ A curable composition is applied either directly or indirectly onto the panel and onto a mould surface [[(6)]] onto which the panel has been positioned. When being applied on the mould surface, the curable composition has a dynamic viscosity which is lower than the dynamic viscosity of extrusion materials. In this way, a better surface quality can be achieved without having to exert a high pressure onto the curable composition. In contrast to the known RIM processes, the curable composition is not injected in a closed mould but is applied onto an open mould surface by means of an applicator device [[(9)]] moving along at least ~~said~~ the portion of the periphery of the panel [[(2)]]. ~~In this way, cheaper moulds can be used and in particular moulds made of a soft, resilient material (8).~~

~~Figure 2~~